

## CDR02BX103BMZP-T&R

Aliases (C1805P103M1XPL7189)

SMD Mil PRF55681, Ceramic, 0.01 uF, 20%, 100 VDC, BX, P (0.1%/1000 Hrs), 1805



Click here for the 3D model.

Dimensions	
Chip Size	1805
L	4.57mm +/-0.38mm (0.18 in +/-0.015 in)
W	1.27mm +/-0.38mm (0.05 in +/-0.015 in)
Т	0.98mm +/-0.42mm (0.039 in +/-0.017 in)
В	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications	,
Packaging	T&R, 178mm, Plastic Tape
Packaging Quantity	2500

General Information	
Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	1c00297e-7f97-4ed1-8a7f-4c4644e8ab84
Termination	Lead (SnPb)
Failure Rate	P (0.1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderPlate 70-30.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.01 uF
Capacitance Tolerance	20%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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